

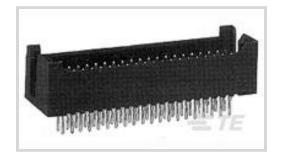
AMPMODU | AMPMODU Headers

TE Internal #: 6-102567-1 PCB Mount Header, Vertical, Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 20

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Fully Shrouded

Printed Circuit Board

Configuration Features

PCB Mount Orientation	Vertical	
Number of Positions	20	
Number of Rows	2	
Board-to-Board Configuration	Parallel	
Electrical Characteristics		
Termination Resistance	12 mΩ	
Operating Voltage	250 VAC	
Body Features		
Primary Product Color	Black	
Contact Features		
Mating Square Post Dimension	.64 mm[.025 in]	
	100 µin	
Contact Shape & Form	Square	

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Copper Alloy	
Contact Mating Area Plating Material	Gold	
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]	
Contact Type	Pin	
Contact Current Rating (Max)	3 A	
Termination Features		
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Post & Tail Length	4.57 mm[.18 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Retention	Without	
Mating Alignment	With	
Mating Alignment Type	Guide Pins	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Thermoplastic	
Dimensions		
Connector Height	13.97 mm[.55 in]	
Row-to-Row Spacing	2.54 mm[.1 in]	
Stack Height	11.43 mm[.45 in]	
PCB Thickness (Recommended)	1.4 mm[.055 in]	
Usage Conditions		
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Solder Process Feature	Board Standoff	
Circuit Application	Signal	
Industry Standards		
Approved Standards	CSA LE7189, UL E28476	

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	56
Packaging Type	Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



PCB Mount Header, Vertical, Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



Also in the Series AMPMODU Headers







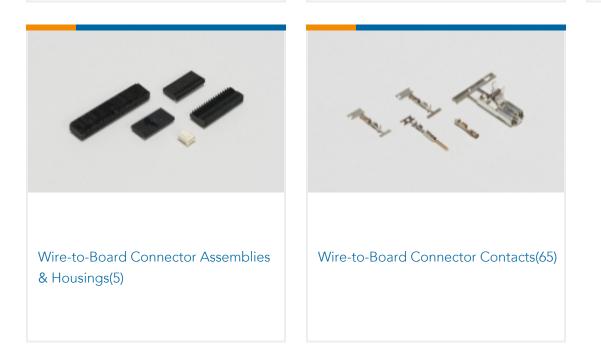


PCB Connector Mounting(1)

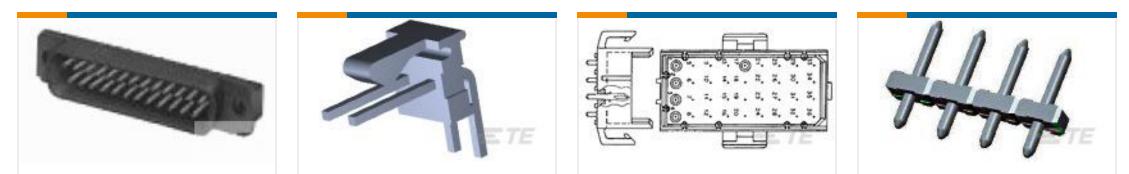
PCB Connector Shrouds(1)

PCB Headers & Receptacles(4872) PCB

PCB Latches, Locks & Retainers(1)



Customers Also Bought



TE Part #5745071-4	TE Part #3-641216-2	TE Part #640506-1	TE Part #1546931-6
HD-20 PLUG 9P VERT FFSCRLK	02P MTA100 HDR ASSY FL/RA LF	36P MR HDR ASSY V0	6P UNSHROUD 5.0 HDR,HIGH TEMP
			elabidatababababababababababababababababababa
TE Part #1437664-4	TE Part #5205818-2	TE Part #533472-2	TE Part #6-102692-5
NC6-P107-02=NC6 ASSEMBLY	FEMALE SCREWLOCK,PLTD	BOX II 4 ROW RECP ASSY 60 POS	16 MODII 2PC HDR DR SHRD, ROHS



PCB Mount Header, Vertical, Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



Documents

Product Drawings 20 MODII 2PC HDR DR SHRD .100,

English

CAD Files

Customer View Model

ENG_CVM_6-102567-1_N3.3d_igs.zip

English

Customer View Model

ENG_CVM_6-102567-1_N3.3d_stp.zip

English

3D PDF

3D

3D PDF

English

Customer View Model

ENG_CVM_6-102567-1_N3.2d_dxf.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION5_CONT

English

Product Environmental Compliance

TE Material Declaration

English